

Title (en)

CLIP CONTACT ELEMENT FOR A PRINTED CIRCUIT BOARD, AND METHOD FOR PRODUCING SAME

Title (de)

KLIPPKONTAKTELEMENT FÜR EINE LEITERPLATTE UND VERFAHREN ZU DESSEN HERSTELLUNG

Title (fr)

ÉLÉMENT DE CONTACT À CLIP POUR CARTE DE CIRCUITS IMPRIMÉS ET PROCÉDÉ POUR SA FABRICATION

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Application

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Abstract (en)

[origin: WO2014135557A1] The invention relates to a clip contact element (16) for a printed circuit board (12), comprising a contact core body (20). At least two inclined guiding elements (22) and at least two contact lip elements (24) extend outwards from the contact core body (20), and the contact core body (20) has at least one conductor contact portion (28). The invention further relates to a connection arrangement (10) with such a clip contact element (16) and to a method (80) for producing same.

IPC 8 full level

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CPC (source: EP)

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